

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/518,511
Priority Filing Date March 3, 2000
Inventor Dinesh Chopra, et al
Assignee Micron Technology, Inc.
Priority Group Art Unit 2825
Priority Examiner L. Malsawma
Attorney's Docket No. MI22-1747
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and
Integrated Circuits Formed Thereby

PRELIMINARY AMENDMENT

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10-16-01

To: Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

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AMENDMENTS

In the Specification

At p. 1, before the "Technical Field" section, insert

--RELATED PATENT DATA

91 This patent resulted from a divisional application of U.S. Patent
Application Serial No. 09/518,511, filed on March 3, 2000.--

In the Claims

Cancel claims 1-46 without prejudice.

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